

Features

- Schottky Brrier Chip
- Low Power Loss,High Efficiency
- Ideally Suited for Automatic Assembly
- Surge Overload Rating to 100APeak
- Plastic Case Material has UL Flammability Classification Rating 94V-0



SMA(DO-214AC)

Mechanical Data

- Case: Molded plastic SMA
- Terminals: Plated leads solderable per MIL-STD-750,Method 2026 guaranteed
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Making: Type Number



Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified Single phase,half

wave,60Hz,resistive or inductive load

For capacitive load derate current by 20%

Type Number	SYMBOL	SS 52	SS 53	SS 54	SS 545	SS 55	SS 56	SS 58	SS 510	SS 515	SS 520	SS 525	Unit
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	20	30	40	45	50	60	80	100	150	200	250	V
Maximum RMS Voltage	V _{RMS}	14	21	28	31	35	42	56	70	105	140	175	V
Maximum DC Blocking Voltage	V _{DC}	20	30	40	45	50	60	80	100	150	200	250	V
Average Rectified Output Current @T _L =100°C	I _{F(AV)}	5.0											A
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	100											A
Rating for fusing (t<8.3ms)	I ² t	41.50											A ² s
Forward Voltage @IF=5.0A	V _{FM}	0.55				0.7		0.85		0.92		0.95	V
Peak Reverse Current @T _A =25°C	I _R	0.1						0.05					mA
At Rated DC Blocking Voltage @T _A =100 °C		10						5					
Typical Junction Capacitance (Note 1)	C _J	170						100					pF
Typical Thermal Resistance	R _{θJA}	45											°C/W
Operating Temperature Range	T _J	-55 to+150											°C
Storage Temperature Range	T _{STG}	-55 to +150											°C

Note:

1. Measured at 1.0 MHz and Applied reverse Voltage of 4.0V D.C

Fig. 1 Forward Current Derating Curve

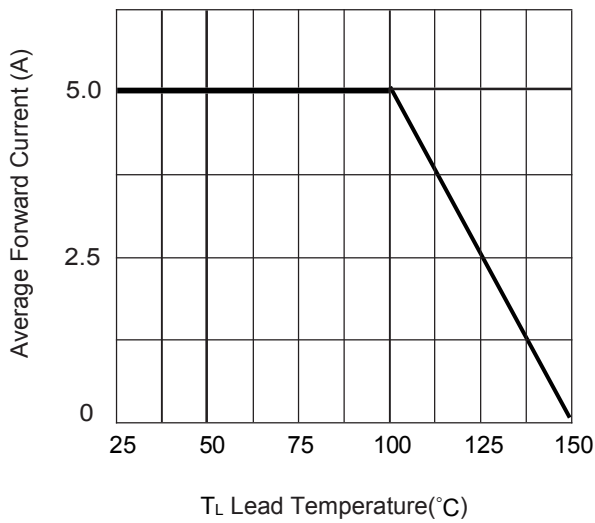


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

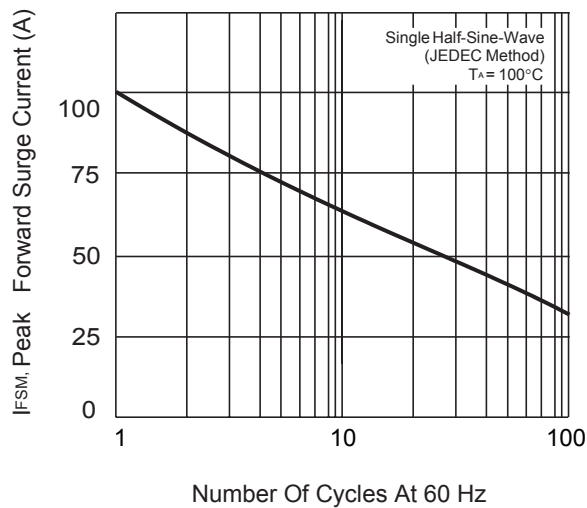


Fig.5 Mounting PAD Layout

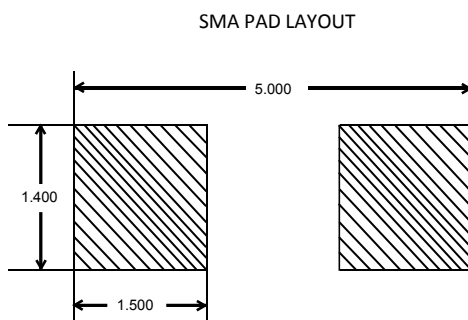


Fig. 2 Typ. Forward Characteristics

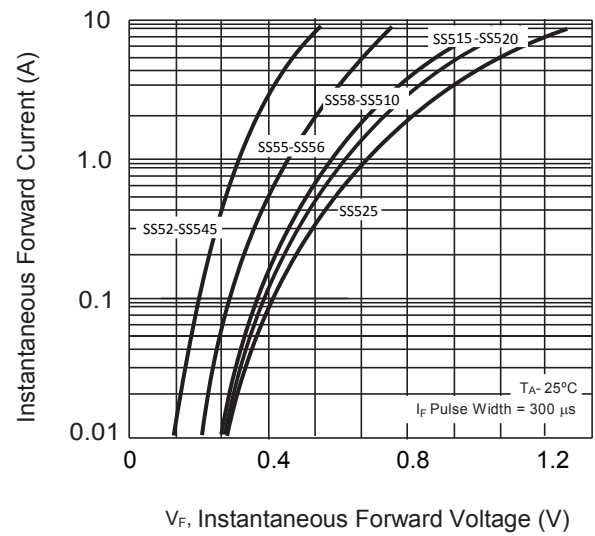
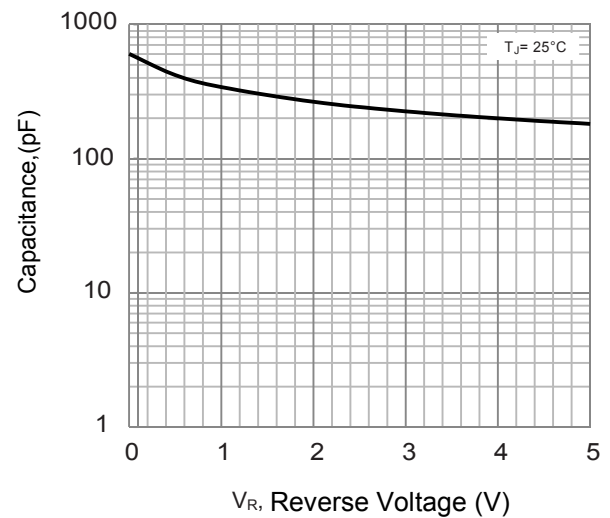
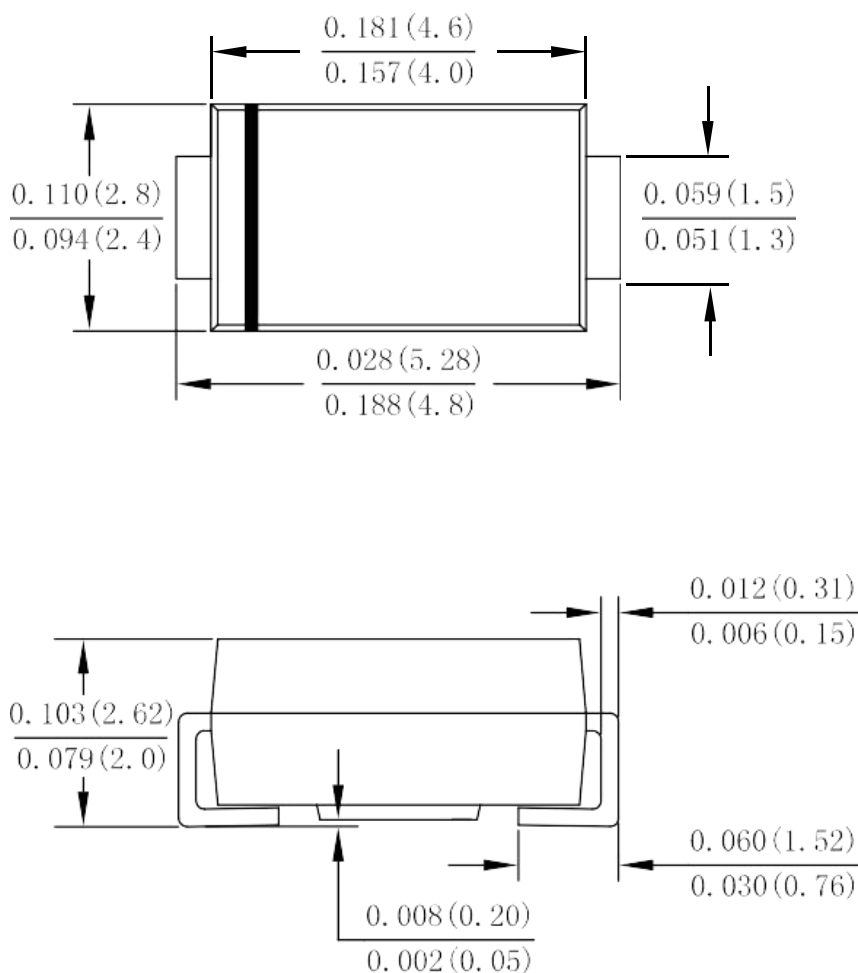


Fig.4 Typical Junction Capacitance



Case: SMA(DO-214AC)

Dimensions in inches and (millimeters)



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